Effect of Cu Negative Ion Implantation on Physical Properties of Zn$_{1-x}$Mn$_x$Te Films

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The paper deals with the investigations of structural properties of Zn$_{1-x}$Mn$_x$Te films, which were fabricated under various deposition conditions using the thermal evaporation method in a closed volume. The surface morphology of the samples was studied, the phase analysis of their structures was performed, the elemental analysis of the films and the crystal lattice constant were investigated. The texture perfection of the films before and after copper ion implantation was evaluated.

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1. Introduction

At present, the interest of specialists working in the field of materials science, more specifically in semimagnetic solid solutions Zn$_{1-x}$Mn$_x$Te has developed since their photoluminescence, magnetic and magnetooptical properties were unique allowing fabrication of a number of effective instruments for micro-, opto-electronics, solar power engineering, and spintronics [1, 2]. Copper is traditionally employed as a doping impurity activating the photoluminescence, as well as for fabrication of doped ZnTe films of high conductivity [3–5]. The ion implantation is considered to be the most efficient method allowing introduction of this impurity to A$_2$B$_6$ compounds [6]. However, the influence of Cu impurity on the properties of Zn$_{1-x}$Mn$_x$Te solid solutions is poorly studied. The work reports the structural properties and the elemental composition of the Zn$_{1-x}$Mn$_x$Te films deposited using close-spaced vacuum sublimation (CSVS) before and after copper ion implantation.

2. Methodology of film preparation and investigations

The thin Zn$_{1-x}$Mn$_x$Te films were deposited on the glass substrates at over $5 \times 10^{-3}$ Pa pressure of the residual gases in the chamber. The detailed description of device, which was employed for the film deposition using the CSVS method, was reported in [7, 8]. The mix material of a semiconducting purity containing 10% of manganese was evaporated. The temperature of the evaporator was $T_e = 800$°C. The substrate temperature varied within the interval $T_s = 150-550$°C. The deposition time was normally $t = 5-15$ min, and the layer thickness was 2–8 μm. Surface morphology of the films was studied using scanning electron microscopy (REMMA-103-01).

Elemental analysis of films was performed using X-ray characteristic radiation induced by a proton beam [9]. The studies were carried out using the electrostatic accelerator Sokol with the energy of a proton beam up to 2 MeV (Institute of Applied Physics, NAS of Ukraine, Sumy) [10]. Summed-up spectra from several areas of the sample surfaces (particle induced X-ray emission, PIXE) were scanned and point-by-point spectra were studied using the micro-beam ($\mu$-PIXE). The scanned film area was usually 200 × 200 μm$^2$. The transverse size of the probe was 4 × 4 μm$^2$, charge $Q = 4 \times 10^{-10}$ C/pixel, raster was 50 × 50 pixels, and the scanning step was 4 μm. The proton energy $E_p$ was 1.5 MeV. The obtained PIXE spectra were processed using the GPIX 3 program. The samples fabricated under optimal conditions ($T_s = 350$°C) were subsequently doped by implantation of negative Cu ions of 60 keV energy and the 10$^{14}$ cm$^{-2}$ fluence using the ion source (NIMS, Tsukuba, Ibaraki, Japan).

Structural studies of the films were performed with the X-ray diffraction device RINT2500MDG in $K_{\alpha}$-emission of the chrome anode. Shooting was performed within 20 angles from 10° to 160° (20 is the Bragg angle). X-ray radiation was focused according to Bragg-Brentano. Curves were normalized to the peak (111) intensity of a cubic phase. Phase analysis was carried out by comparing the interplanar spacings and relative intensities of X-ray peaks of the studied samples and the standards of JCPDS [11]. The film textures were measured by the Harris method [12–14]. The Zn$_{1-x}$Mn$_x$Te powder was used as the standard of a non-textured sample. The lattice constant value of Zn$_{1-x}$Mn$_x$Te films was determined by the position of $K_{\alpha}$ component of all most intensive lines present in the diffraction patterns. Subsequently, to obtain precise values of constants, we used

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the extrapolation methods of Nelson-Riley and Bradley-Jay [13, 14]. The separation of the doublet was achieved by the Rechinger method using the package of applied programs DIFWIN.

3. Investigation results and discussion

Based on the studies, it was proved that the growth of the Zn$_{1-x}$Mn$_x$Te films was similar to the growth of other chalcogenides [7, 8, 15-17]. The investigated films had the grain size $D = 0.50-1.12 \mu m$ and $l = 2-8 \mu m$ thickness. The grain size increased with the substrate temperature. Electron-microscopic images of the Zn$_{1-x}$Mn$_x$Te surfaces and their cross-sections obtained at various temperatures of the substrates are shown in Fig. 1. The analysis demonstrated that the calculated values of $D$ were somewhat lower than those of the ZnTe films deposited under similar conditions [16, 17].

The PIXE method, which was employed to study the Zn$_{1-x}$Mn$_x$Te films, showed the presence of manganese in several surface areas. The analysis of the element compositions of the initial films is summarized in Table I. It was shown that the average concentration of manganese in the samples was 1.62-3.04 at.%. When the substrate temperature increased from $T_s = 350^\circ C$ to $550^\circ C$, it decreased. In addition, the investigated films were characterized by the dominating content of tellurium compared with zinc ($C_{Zn}/C_{Te} = 0.70-0.87$). The uncontrolled and residual impurities were not identified in the studied samples. Scanning the sample surfaces by the proton beam ($\mu$-PIXE) we found that manganese was uniformly distributed over their areas.

![Fig. 1. SEM images of surface (a, c) and cross-section of the Zn$_{1-x}$Mn$_x$Te films (b, d) obtained at $T_s = 800^\circ C$ and deposited at the substrate temperature $T_s [^\circ C]$: 150 (a, b), 550 (c, d).](image)

<table>
<thead>
<tr>
<th>$T_s$ [°C]</th>
<th>$T_e$ [°C]</th>
<th>Zn wt%</th>
<th>Mn wt%</th>
<th>Te wt%</th>
<th>Zn [at.%]</th>
<th>Mn [at.%]</th>
<th>Te [at.%]</th>
<th>$C_{Zn}/C_{Te}$</th>
<th>$C_{Zn+Mn}/C_{Te}$</th>
</tr>
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</table>
the material lattice constant ( \( a = 0.60998 \text{ to } 0.61043 \text{ nm} \) ) are lower than those of the ZnTe films fabricated under the same conditions ( \( a = 0.60890 \text{ to } 0.61165 \text{ nm} \) ) [16, 17]. This is apparently due to the substitution in the lattice of Zn by Mn atoms, since the latter have a lower atomic radius [1, 2]. Some results of \( a \) measurements in the Zn\(_{1-x}\)Mn\(_x\)Te films before and after Cu implantation are presented in Table II. It can be seen that the lattice constant of the material evidently increased after copper implantation.

4. Conclusion

The paper deals with the studies of surface morphology and structural features of the Zn\(_{1-x}\)Mn\(_x\)Te films, which were deposited using the CSVS method under various physical and technological deposition regimes. The main points of the conclusion are as following:

1. It was determined that the thin Zn\(_{1-x}\)Mn\(_x\)Te films with the thickness of about 2 to 8 \( \mu \text{m} \) had the grain size \( D = 0.50 \text{ to } 1.12 \mu \text{m} \), which increased with the substrate temperature. The thin films were single-phase with a stable cubic structure. The axial [111] growth of the texture was determined with the help of the inverse pole figure. The orientation factor increased with the substrate temperature.

2. The Mn concentration changed with the growth conditions in the range from 1.6 to 3.0 at.%. Scanning of the films surfaces by the proton (\( \mu \)-PIXE) revealed the uniform distribution of Mn over their surfaces.

3. It was found that the experimental values of the lattice constant of Zn\(_{1-x}\)Mn\(_x\)Te solid solution ( \( a = 0.60998 \text{ to } 0.61043 \text{ nm} \) ) were lower than those of ZnTe films ( \( a = 0.60980 \text{ to } 0.61165 \text{ nm} \) ) deposited under the same conditions. Copper ion implantation resulted in the increase of the material lattice constant.

4. It was found that the implantation influences on the formation of precipitates in the film composition, texture quantity, and the lattice constant of the film.

References


